



FGA70N30TD 300V, 70A PDP IGBT

Features

- High current capability
- Low saturation voltage: $V_{CE(sat)} = 1.5V @ I_C = 40A$
- High input impedance
- Fast switching
- RoHS compliant

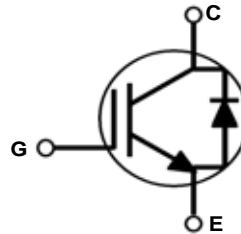
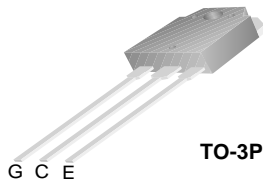


Application

. PDP System

General Description

Using Novel Trench IGBT Technology, Fairchild's new series of trench IGBTs offer the optimum performance for PDP applications where low conduction and switching losses are essential.



Absolute Maximum Ratings

| Symbol | Description | Ratings | Units |
|--------------------------|---|-------------|-------|
| V_{CES} | Collector-Emitter Voltage | 300 | V |
| V_{GES} | Gate-Emitter Voltage | ±30 | V |
| $I_C \text{ pulse}(1)^*$ | Pulsed Collector Current @ $T_C = 25^\circ\text{C}$ | 160 | A |
| I_F | Diode Continuous Forward Current @ $T_C = 100^\circ\text{C}$ | 10 | A |
| I_{FM} | Diode Maximum Forward Current | 40 | A |
| P_D | Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$ | 201 | W |
| | Maximum Power Dissipation @ $T_C = 100^\circ\text{C}$ | 90.6 | W |
| T_J | Operating Junction Temperature | -55 to +150 | °C |
| T_{stg} | Storage Temperature Range | -55 to +150 | °C |
| T_L | Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds | 300 | °C |

Thermal Characteristics

| Symbol | Parameter | Typ. | Max. | Units |
|-------------------------------|--|------|------|-------|
| $R_{\theta JC}(\text{IGBT})$ | Thermal Resistance, Junction-to-Case | -- | 0.62 | °C/W |
| $R_{\theta JC}(\text{DIODE})$ | Thermal Resistance, Junction-to-Case for Diode | -- | 1.56 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | -- | 40 | °C/W |

Notes:

(1) Repetitive test, pulse width = 100µsec, Duty = 0.2

* I_{C_pulse} limited by max T_J

Package Marking and Ordering Information

| Device Marking | Device | Package | Packaging Type | Qty per Tube | Max Qty per Box |
|----------------|--------------|---------|----------------|--------------|-----------------|
| FGA70N30TD | FGA70N30TDTU | TO-3P | Tube | 30ea | - |

Electrical Characteristics T_C = 25°C unless otherwise noted

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|---|--|---|------|------|-------|-------|
| Off Characteristics | | | | | | |
| BV _{CES} | Collector-Emitter Breakdown Voltage | V _{GE} = 0V, I _C = 250uA | 300 | -- | -- | V |
| ΔBV _{CES} / ΔT _J | Temperature Coefficient of Breakdown Voltage | V _{GE} = 0V, I _C = 250uA | -- | 0.2 | -- | V/°C |
| I _{CES} | Collector Cut-Off Current | V _{CE} = V _{CES} , V _{GE} = 0V | -- | -- | 250 | uA |
| I _{GES} | G-E Leakage Current | V _{GE} = V _{GES} , V _{CE} = 0V | -- | -- | ± 400 | nA |
| On Characteristics | | | | | | |
| V _{GE(th)} | G-E Threshold Voltage | I _C = 250uA, V _{CE} = V _{GE} | 3.0 | 4.5 | 5.5 | V |
| V _{CE(sat)} | Collector to Emitter Saturation Voltage | I _C = 20A, V _{GE} = 15V | -- | 1.2 | 1.5 | V |
| | | I _C = 40A, V _{GE} = 15V | -- | 1.5 | -- | V |
| | | I _C = 70A, V _{GE} = 15V T _C = 25°C | -- | 1.8 | -- | V |
| | | I _C = 70A, V _{GE} = 15V T _C = 125°C | -- | 1.9 | -- | V |
| Dynamic Characteristics | | | | | | |
| C _{ies} | Input Capacitance | V _{CE} = 30V, V _{GE} = 0V f = 1MHz | -- | 3000 | -- | pF |
| C _{oes} | Output Capacitance | | -- | 160 | -- | pF |
| C _{res} | Reverse Transfer Capacitance | | -- | 110 | -- | pF |
| Switching Characteristics | | | | | | |
| t _{d(on)} | Turn-On Delay Time | V _{CC} = 200V, I _C = 40A R _G = 15Ω, V _{GE} = 15V Resistive Load, T _C = 25°C | -- | 32 | -- | ns |
| t _r | Rise Time | | -- | 90 | -- | ns |
| t _{d(off)} | Turn-Off Delay Time | | -- | 175 | -- | ns |
| t _f | Fall Time | | -- | 170 | 300 | ns |
| t _{d(on)} | Turn-On Delay Time | V _{CC} = 200V, I _C = 40A R _G = 15Ω, V _{GE} = 15V Resistive Load, T _C = 125°C | -- | 30 | -- | ns |
| t _r | Rise Time | | -- | 90 | -- | ns |
| t _{d(off)} | Turn-Off Delay Time | | -- | 185 | -- | ns |
| t _f | Fall Time | | -- | 235 | -- | ns |
| Q _g | Total Gate Charge | V _{CE} = 200V, I _C = 40A V _{GE} = 15V | -- | 125 | -- | nC |
| Q _{ge} | Gate-Emitter Charge | | -- | 25 | -- | nC |
| Q _{gc} | Gate-Collector Charge | | -- | 55 | -- | nC |

Electrical Characteristics of DIODE $T_C = 25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units | |
|----------|-------------------------------------|--|---------------------------|------|------|-------|----|
| V_{FM} | Diode Forward Voltage | $I_F = 10\text{A}$ | $T_C = 25^\circ\text{C}$ | -- | 1.1 | 1.4 | V |
| | | | $T_C = 125^\circ\text{C}$ | -- | 0.9 | -- | |
| t_{rr} | Diode Reverse Recovery Time | $I_F = 10\text{A}$ | $T_C = 25^\circ\text{C}$ | -- | 21 | -- | ns |
| | | | $T_C = 125^\circ\text{C}$ | -- | 35 | -- | |
| I_{rr} | Diode Peak Reverse Recovery Current | $dI/dt = 200\text{A}/\mu\text{s}$ Diode Forward Voltage | $T_C = 25^\circ\text{C}$ | -- | 2.8 | -- | A |
| | | | $T_C = 125^\circ\text{C}$ | -- | 5.6 | -- | |
| Q_{rr} | Diode Reverse Recovery Charge | | $T_C = 25^\circ\text{C}$ | -- | 29.4 | -- | nC |
| | | | $T_C = 125^\circ\text{C}$ | -- | 98 | -- | |

Typical Performance Characteristics

Figure 1. Typical Output Characteristics

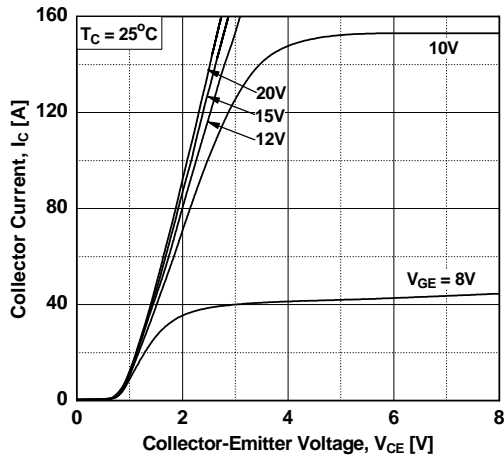


Figure 2. Typical Output Characteristics

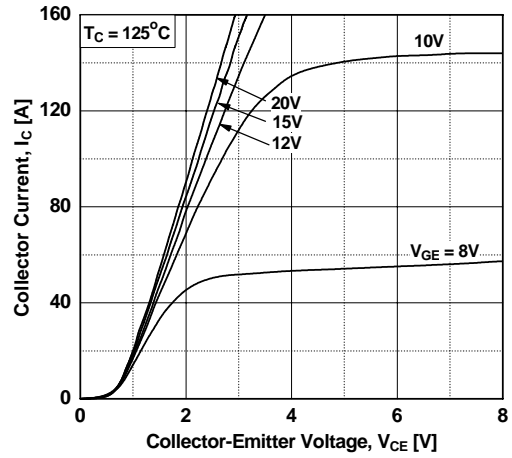


Figure 3. Typical Saturation Voltage Characteristics

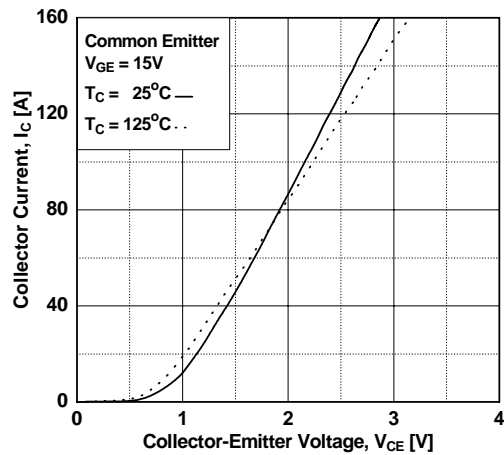


Figure 4. Transfer Characteristics

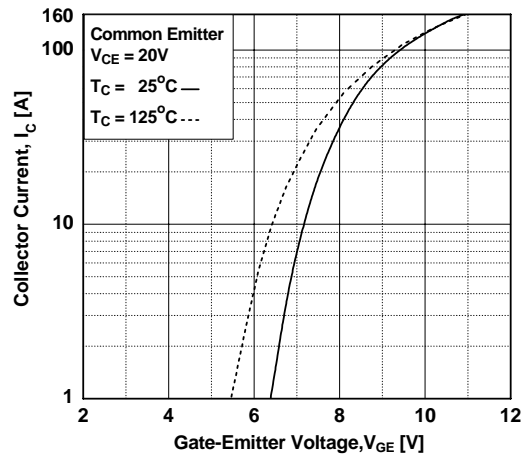


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

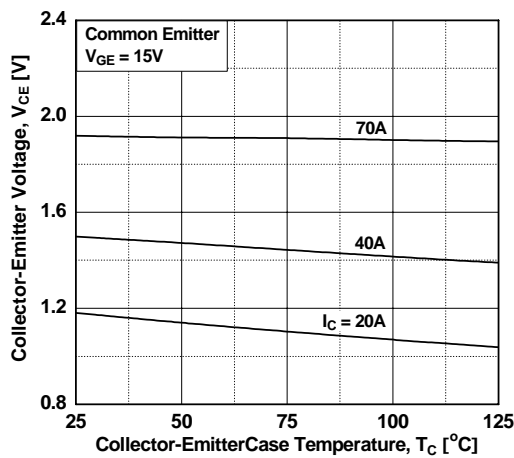
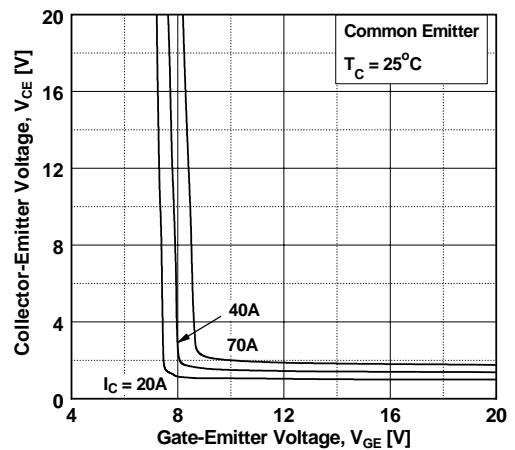


Figure 6. Saturation Voltage vs. Vge



Typical Performance Characteristics (Continued)

Figure 7. Saturation Voltage vs. V_{GE}

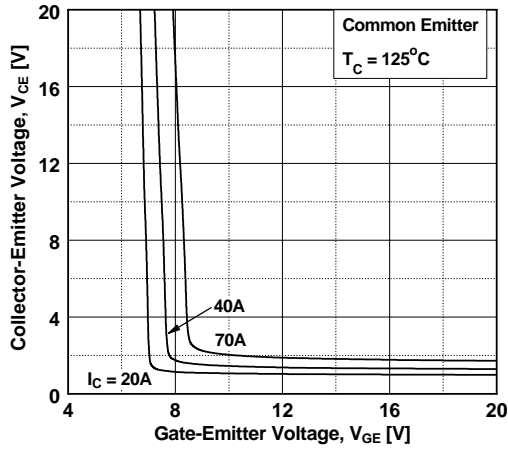


Figure 8. Capacitance Characteristics

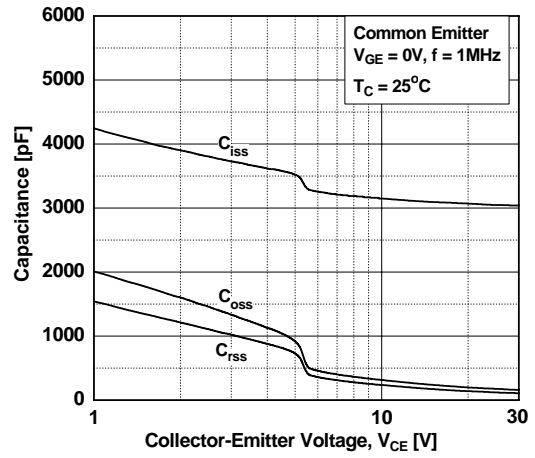


Figure 9. Gate Charge Characteristics

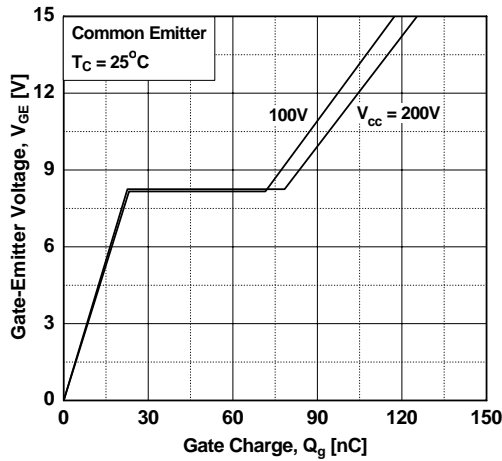


Figure 10. SOA Characteristics

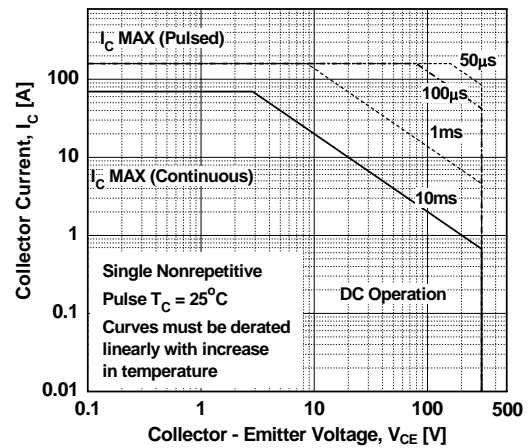


Figure 11. Turn-on Characteristics vs. Gate Resistance

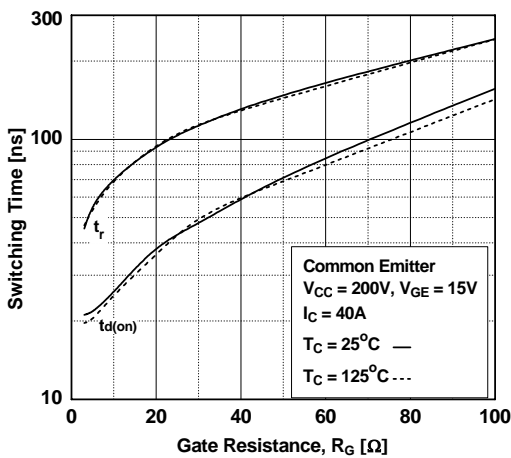
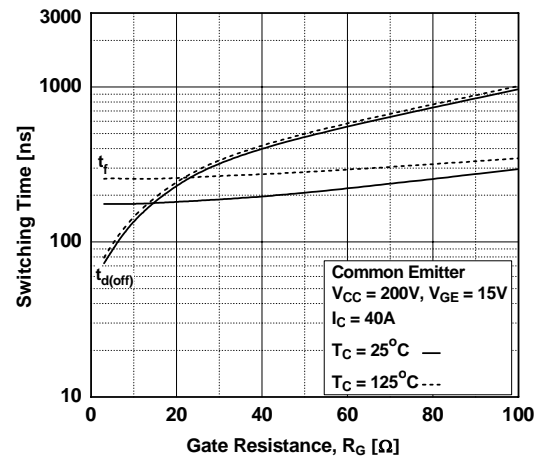


Figure 12. Turn-off Characteristics vs. Gate Resistance



Typical Performance Characteristics (Continued)

Figure 13. Turn-on Characteristics vs. Collector Current

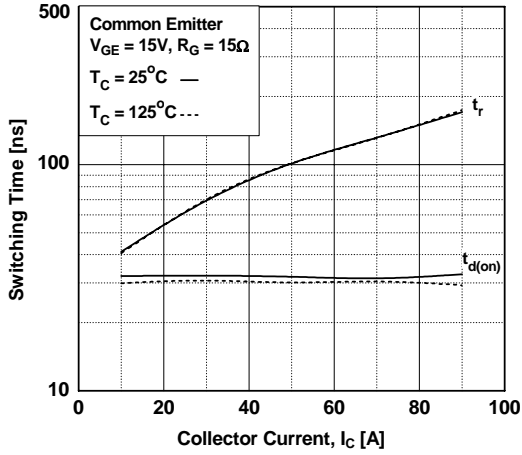


Figure 14. Turn-off Characteristics vs. Collector Current

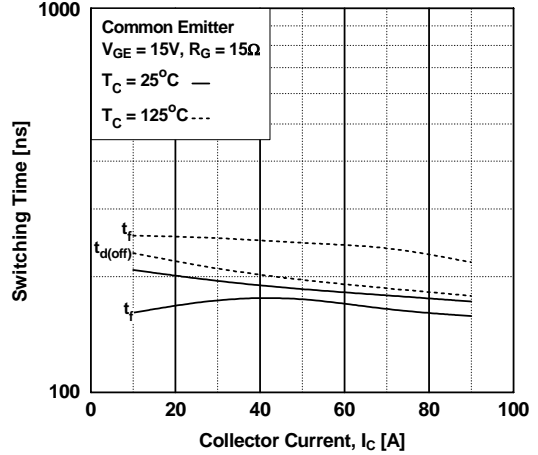


Figure 15. Switching Loss vs. Gate Resistance

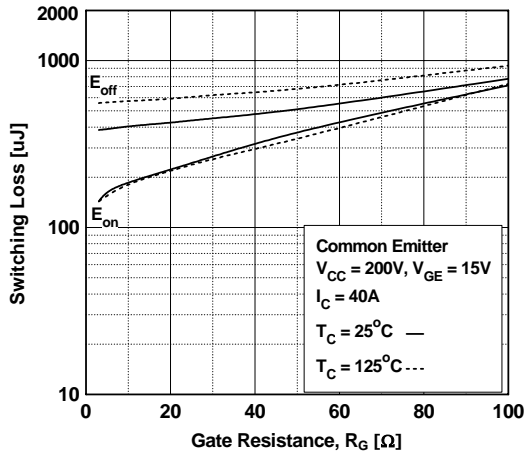


Figure 16. Switching Loss vs. Collector Current

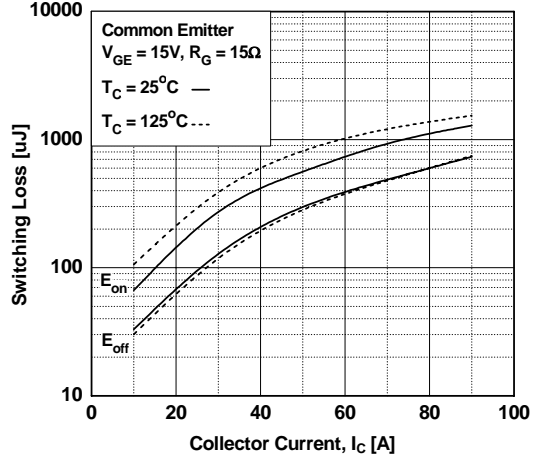
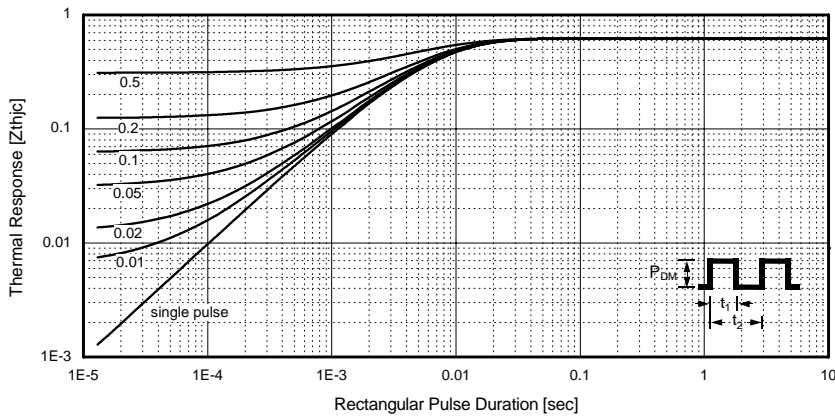


Figure 17. Transient Thermal Impedance of IGBT



Typical Performance Characteristics (Continued)

Figure 18. Forward Characteristics

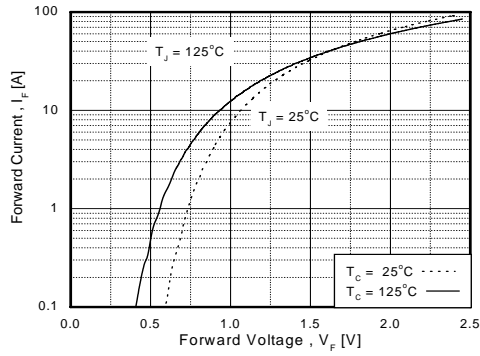


Figure 19. Typical Reverse Recovery Current

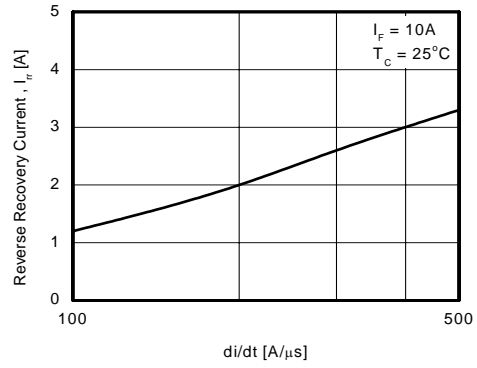
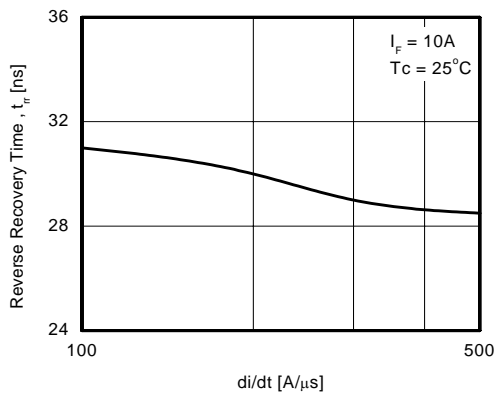
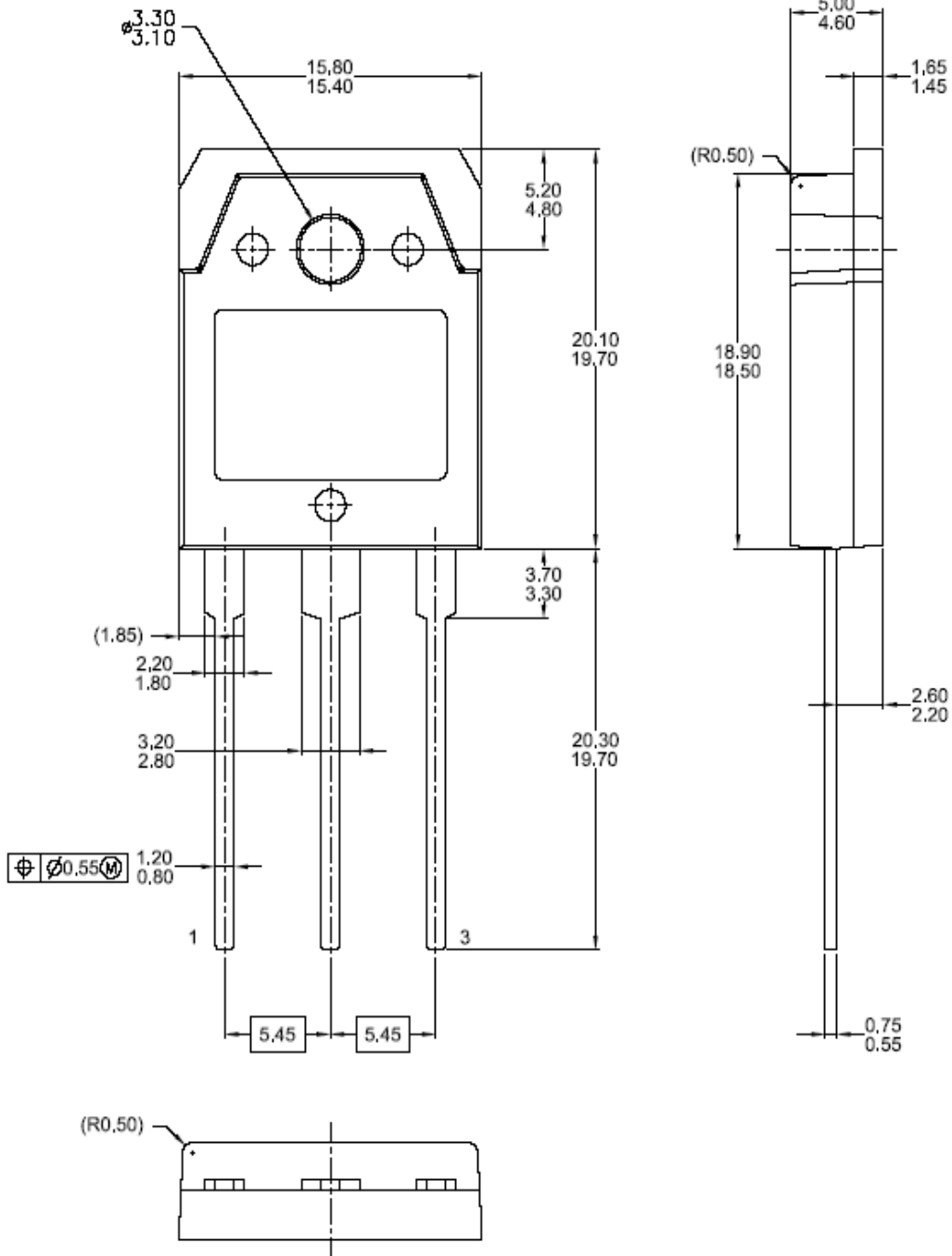


Figure 20. Typical Reverse Recovery Time



TO-3PN





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